ABSOLUTION CONNECTING ELECTRONICS INDUSTRIESS INDUSTRIESS INDUSTRIESS	ockburn, Illinois. A	All rights reserved u ntions.	under both	This docume level parts, t	ent is a declar he declaration	ation of the s	substances es all lowe	within the manuf r level materials	acturer listed for which the	l item. N manufa	ote: if the	e item is an as s engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg In						ormation			
Supplier Information														
ompany name* Company unique ID				Unique ID Authority					Respo	Response Date*				
onsemi	nsemi				2023-06-08									
Title - Contact				]	Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Enviro Compliance					NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative				]	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards	nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr	Item Number	Mfr Item Name		·	Effective Da	te Versior	n I	Manufacturing Site		Weigh	t*	UOM	Unit Type	
FAI	AN5308MPX DC/DC 1.3MH		z Buck 800mA		2023-06-08		TH2			14.3716		mg	Each	
Manufacturing Proccess Information							1			•		1	I	
Terminal Plating / Grid Array Material	Terminal Base	Ferminal Base Alloy		L Rating	Peak Process Body Tempera		Femperatu	ure Max Time at Peak Temp		ature	ature Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no CU Alloy Sn)		1	1		260		С	30		onds 3				
Comments	·				·			•	<u> </u>					
evel 1 - maximum time at peak temperature durir	g soldering is 10-3	0 seconds												
for more information regarding material composition	ion please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.308	mg	Supplier	Silicon (Si)	7440-21-3		1.308	mg
Die Attach	0.188	mg	Supplier	Silver (Ag)	7440-22-4		0.156	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.032	mg
Lead Frame	6.3137	mg	Supplier	Zinc (Zn)	7440-66-6		0.0079	mg
			Supplier	Iron (Fe)	7439-89-6		0.1483	mg
			Supplier	Copper (Cu)	7440-50-8		6.1523	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0052	mg
Mold Compound-Black	6.2844	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.3457	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0126	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.0463	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.8798	mg
Plating	0.0885	mg	Supplier	Silver (Ag)	7440-22-4		0.0017	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0031	mg
			В	Nickel (Ni)	7440-02-0		0.0819	mg
			Supplier	Gold (Au)	7440-57-5		0.0018	mg
Wire Bond - Au	0.189	mg	Supplier	Gold (Au)	7440-57-5		0.189	mg